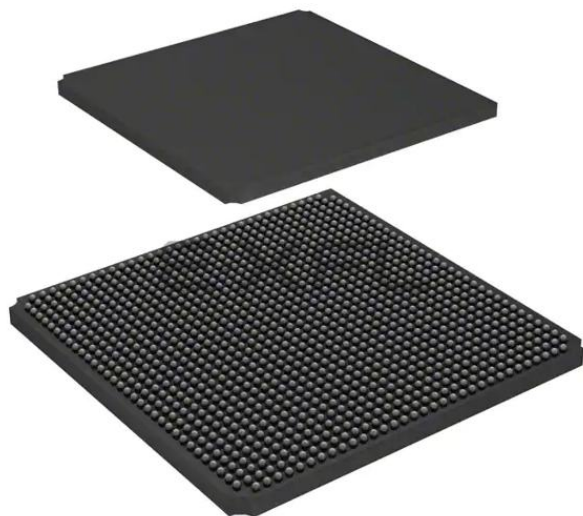




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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

Product Status	Obsolete
Number of LABs/CLBs	20000
Number of Logic Elements/Cells	80000
Total RAM Bits	5816320
Number of I/O	660
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1152-BCBGA, FCBGA
Supplier Device Package	1152-CFCBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfsc3ga80e-6fc1152c

Table 1-1. LatticeSC Family Selection Guide¹

Device	SC15	SC25	SC40	SC80	SC115
LUT4s (K)	15	25	40	80	115
sysMEM Blocks (18Kb)	56	104	216	308	424
Embedded Memory (Mbits)	1.03	1.92	3.98	5.68	7.8
Max. Distributed Memory (Mbits)	0.24	0.41	0.65	1.28	1.84
Number of 3.8Gbps SERDES (Max.)	8	16	16	32	32
DLLs	12	12	12	12	12
Analog PLLs	8	8	8	8	8
MACO Blocks	4	6	10	10	12
Package I/O/SERDES Combinations (1mm ball pitch)					
256-ball fpBGA (17 x 17mm)	139/4				
900-ball fpBGA (31 x 31mm)	300/8	378/8			
1020-ball fcBGA (33 x 33mm) ²		476/16	562/16		
1152-ball fcBGA (35 x 35mm) ³			604/16	660/16	660/16
1704-ball fcBGA (42.5 x 42.5mm) ³				904/32	942/32

1. The information in this preliminary data sheet is by definition not final and subject to change. Please consult the Lattice web site and your local Lattice sales office to ensure you have the latest information regarding the specifications for these products as you make critical design decisions.
2. Organic fcBGA converted to organic fcBGA revision 2 per [PCN #02A-10](#).
3. Ceramic fcBGA converted to organic fcBGA per [PCN #01A-10](#).

The LatticeSCM devices add MACO-enabled IP functionality to the base LatticeSC devices. Table 1-2 shows the type and number of each pre-engineered IP core.

Table 1-2. LatticeSCM Family

Device	SCM15	SCM25	SCM40	SCM80	SCM115
flexiMAC Blocks • 1GbE Mode • 10GbE Mode • PCI Express Mode	1	2	2	2	4
SPI4.2 Blocks	1	2	2	2	2
Memory Controller Blocks • DDR/DDR2 DRAM Mode • QDR II/II+ SRAM Mode • RLDRAM I • RLDRAM II CIO/SIO	1	2	2	2	2
Low-Speed CDR Blocks	0	0	2	2	2
PCI Express LTSSM (PHY) Blocks	1	0	2	2	2

Note: See each IP core user's guide for more information about support for specific LatticeSCM devices.

Introduction

The LatticeSC family of FPGAs combines a high-performance FPGA fabric, high-speed SERDES, high-performance I/Os and large embedded RAM in a single industry leading architecture. This FPGA family is fabricated in a state of the art technology to provide one of the highest performing FPGAs in the industry.

This family of devices includes features to meet the needs of today's communication network systems. These features include SERDES with embedded advance PCS (Physical Coding sub-layer), up to 7.8 Mbits of sysMEM embedded block RAM, dedicated logic to support system level standards such as RAPIDIO, SPI4.2, SFI-4, UTOPIA, XGMII and CSIX. The devices in this family feature clock multiply, divide and phase shift PLLs, numerous

Table 2-6. Input/Output/Tristate Gearing Resource Rules

PIO	Input/Output Logic			Tri-State/Bidi	
	x1	x2	x4	x1	x2/x4
A	?	?	?	?	N/A
B	?	No I/O Logic	No I/O Logic	?	N/A
C	?	?	No I/O Logic	?	N/A
D	?	No I/O Logic	No I/O Logic	?	N/A

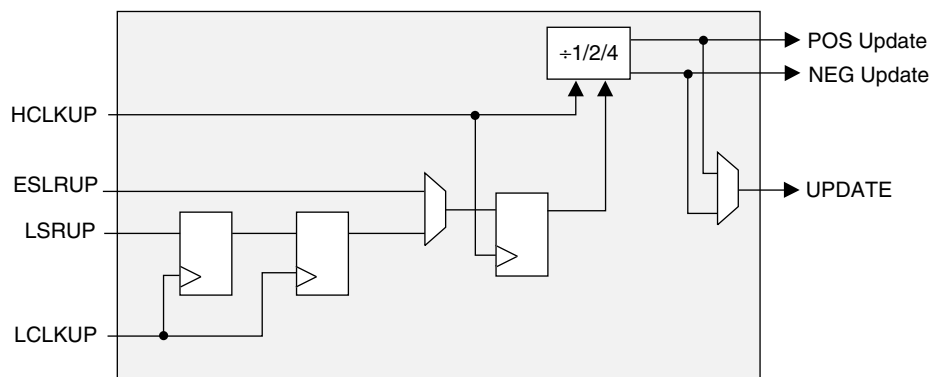
Note: Pin can still be used without I/O logic.

Control Logic Block

The control logic block allows the modification of control signals selected by the routing before they are used in the PIO. It can optionally invert all signals passing through it except the Global Set/Reset. Global Set/Reset can be enabled or disabled. It can route either the edge clock or the clock to the high-speed clock nets. The clock provided to the PIO by routing is used as the slow-speed clocks. In addition this block contains delays that can be inserted in the clock nets to enable Lattice's unique cycle boosting capability.

Update Block

The update block is used to generate the POS update and NEG update signals used by the DDR/Shift register blocks within the PIO. Note the update block is only required in shift modes. This is required in order to do the high speed to low speed handoff. One of these update signals is also selected and output from the PIC as the signal UPDATE. It consists of a shift chain that operates off either the high-speed input or output clock. The values of each register in the chain are set or reset depending on the desired mode of operation. The set/reset signal is generated from either the edge reset ELSR or the local reset LSR. These signals are optionally inverted by the Control Logic Block and provided to the update block as ELSRUP and LSRUP. The Lattice design tools automatically configure and connect the update block when one of the DDR or shift register primitives is used.

Figure 2-25. Update Block

PURESPEED I/O Buffer

Each I/O is associated with a flexible buffer referred to as PURESPEED I/O buffer. These buffers are arranged around the periphery of the device in seven groups referred to as Banks. The PURESPEED I/O buffers allow users to implement the wide variety of standards that are found in today's systems including LVCMOS, SSTL, HSTL, LVDS and LVPECL. The availability of programmable on-chip termination for both input and output use, further enhances the utility of these buffers.

this allows for easy integration with the rest of the system. These capabilities make the LatticeSC ideal for many multiple power supply and hot-swap applications. The maximum current during hot socketing is 4mA. See Hot Socketing Specifications in Chapter 3 of this data sheet.

Power-Up Requirements

To prevent high power supply and input pin currents, each VCC, VCC12, VCCAUX, VCCIO and VCCJ power supplies must have a monotonic ramp up time of 75 ms or less to reach its minimum operating voltage. Apart from VCC and VCC12, which have an additional requirement, and VCCIO and VCCAUX, which also have an additional requirement, the VCC, VCC12, VCCAUX, VCCIO and VCCJ power supplies can ramp up in any order, with no restriction on the time between them. However, the ramp time for each must be 75 ms or less. Configuration of the device will not proceed until the last power supply has reached its minimum operating voltage.

Additional Requirement for VCC and VCC12:

VCC12 must always be higher than VCC. This condition must be maintained at ALL times, including during power-up and power-down. Note that for 1.2V only operation, it is advisable to source both of these supplies from the same power supply.

Additional Requirement for VCCIO and VCCAUX:

If any VCCIOs are 1.2/1.5/1.8V, then VCCAUX MUST be applied before them. If any VCCIO is 1.2/1.5/1.8V and is powered up before VCCAUX, then when VCCAUX is powered up, it may drag VCCIO up with it as it crosses through the VCCIO value. (Note: If the VCCIO supply is capable of sinking current, as well as the more usual sourcing capability, this behavior is eliminated. However, the amount of current that the supply needs to sink is unknown and is likely to be in the hundreds of milliamps range).

Power-Down Requirements

To prevent high power supply and input pin currents, power must be removed monotonically from either VCC or VCCAUX (and must reach the power-down trip point of 0.5V for VCC, 0.95V for VCCAUX) before power is removed monotonically from VCC12, any of the VCCIOs, or VCCJ. Note that VCC12 can be removed at the same time as VCC, but it cannot be removed earlier. In many applications, VCC and VCC12 will be sourced from the same power supply and so will be removed together. For systems where disturbance of the user pins is a don't care condition, the power supplies can be removed in any order as long as they power down monotonically within 200ms of each other.

Additionally, if any banks have VCCIO=3.3V nominal (potentially banks 1, 4, 5) then VCCIO for those banks must not be lower than VCCAUX during power-down. The normal variation in ramp-up times of power supplies and voltage regulators is not a concern here.

Note: The SERDES power supplies are NOT included in these requirements and have no specific sequencing requirements. However, when using the SERDES with VDDIB or VDDOB that is greater than 1.2V (1.5V nominal for example), the SERDES should not be left in a steady state condition with the 1.5V power applied and the 1.2V power not applied. Both the 1.2V and 1.5V power should be applied to the SERDES at nominally the same time. The normal variation in the ramp-up times of power supplies and voltage regulators is not a concern here.

SERDES Power Supply Sequencing Requirements

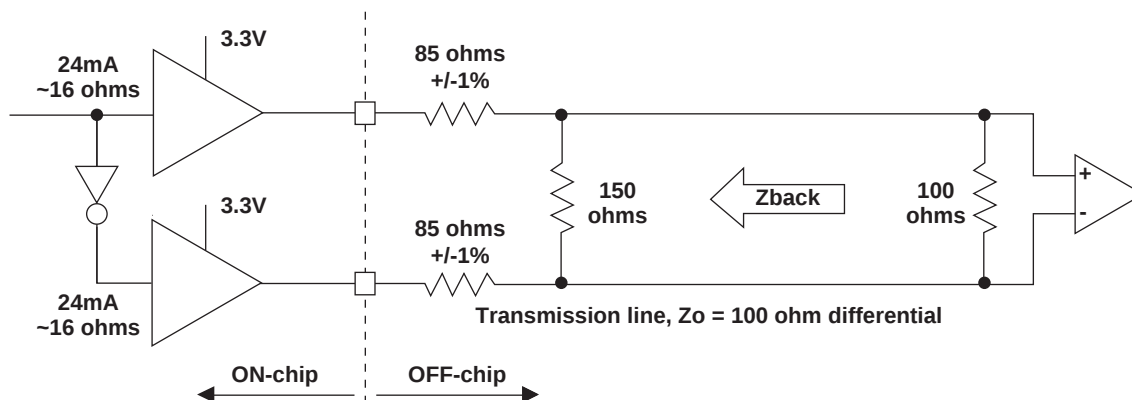
When using the SERDES with 1.5V VDDIB or VDDOB supplies, the SERDES should not be left in a steady state condition with the 1.5V power applied and the 1.2V power not applied. Both the 1.2V and the 1.5V power should be applied to the SERDES at nominally the same time. The normal variation in ramp-up times of power supplies and voltage regulators is not a concern.

Additional Requirement for SERDES Power Supply

All VCC12 pins need to be connected on all devices independent of functionality used on the device. This analog supply is used by both the RX and TX portions of the SERDES and is used to control the core SERDES logic regardless of the SERDES being used in the design. VDDIB and VDDOB are used as supplies for the terminations on the CML input and output buffers. If a particular channel is not used, these can be UNCONNECTED (floating).

LVPECL

The LatticeSC devices support differential LVPECL standard. This standard is emulated using controlled impedance complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The scheme shown in Figure 3-3 is one possible solution for point-to-point signals.

Figure 3-3. Differential LVPECL**Table 3-3. LVPECL DC Conditions¹****Over Recommended Operating Conditions**

Symbol	Description	Nominal	Units
Z_{OUT}	Output impedance	16	ohm
R_S	Driver series resistor	85	ohm
R_P	Driver parallel resistor	150	ohm
R_T	Receiver termination	100	ohm
V_{OH}	Output high voltage	2.03	V
V_{OL}	Output low voltage	1.27	V
V_{OD}	Output differential voltage	0.76	V
V_{CM}	Output common mode voltage	1.65	V
Z_{BACK}	Back impedance	86	ohm
I_{DC}	DC output current	12.6	mA

1. For input buffer, see LVDS table.

For further information on LVPECL, BLVDS, MLVDS and other differential interfaces please see details of additional technical documentation at the end of this data sheet.

On-die Differential Common Mode Termination

Symbol	Description	Min.	Typ.	Max.	Units
C_{CMT}	Capacitance V_{CMT} to GND	—	40	—	pF

LatticeSC/M Family Timing Adders (Continued)

Over Recommended Operating Conditions at VCC = 1.2V +/- 5%

Buffer Type	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
GTLPLUS15	GTLPLUS15	-0.013	-0.017	0.012	0.004	0.037	0.024	ns
GTL12	GTL12	-0.063	-0.071	-0.007	-0.048	0.056	-0.032	ns
Output Adjusters								
LVDS	LVDS	0.708	0.854	0.856	1.021	1.005	1.189	ns
RSDS	RSDS	0.708	0.854	0.856	1.021	1.005	1.189	ns
BLVDS25	BLVDS	-0.129	0.05	-0.136	0.069	-0.136	0.083	ns
MLVDS25	MLVDS	-0.059	0.059	-0.057	0.096	-0.054	0.133	ns
LVPECL33	LVPECL	-0.334	-0.181	-0.325	-1.389	-0.315	-2.598	ns
HSTL18_I	HSTL_18 class I	0.132	0.209	0.153	0.24	0.175	0.272	ns
HSTL18_II	HSTL_18 class II	0.24	0.176	0.268	0.255	0.298	0.333	ns
HSTL18D_I	Differential HSTL 18 class I	0.132	0.209	0.153	0.24	0.175	0.272	ns
HSTL18D_II	Differential HSTL 18 class II	0.24	0.176	0.268	0.255	0.298	0.333	ns
HSTL15_I	HSTL_15 class I	0.096	0.172	0.112	0.198	0.129	0.224	ns
HSTL15_II	HSTL_15 class II	0.208	0.131	0.233	0.203	0.259	0.275	ns
HSTL15D_I	Differential HSTL 15 class I	0.096	0.172	0.112	0.198	0.129	0.224	ns
HSTL15D_II	Differential HSTL 15 class II	0.208	0.131	0.233	0.203	0.259	0.275	ns
SSTL33_I	SSTL_3 class I	0.133	0.177	0.11	0.166	0.088	0.154	ns
SSTL33_II	SSTL_3 class II	0.173	0.247	0.164	0.253	0.156	0.258	ns
SSTL33D_I	Differential SSTL_3 class I	0.133	0.177	0.11	0.166	0.088	0.154	ns
SSTL33D_II	Differential SSTL_3 class II	0.173	0.247	0.164	0.253	0.156	0.258	ns
SSTL25_I	SSTL_2 class I	0.215	0.125	0.239	0.228	0.264	0.331	ns
SSTL25_II	SSTL_2 class II	0.277	0.181	0.311	0.284	0.345	0.387	ns
SSTL25D_I	Differential SSTL_2 class I	0.215	0.125	0.239	0.228	0.264	0.331	ns
SSTL25D_II	Differential SSTL_2 class II	0.277	0.181	0.311	0.284	0.345	0.387	ns
SSTL18_I	SSTL_2 class I	0.16	0.081	0.179	0.173	0.199	0.265	ns
SSTL18_II	SSTL_2 class II	0.238	0.15	0.263	0.244	0.295	0.338	ns
SSTL18D_I	Differential SSTL_2 class I	0.16	0.081	0.179	0.173	0.199	0.265	ns
SSTL18D_II	Differential SSTL_2 class II	0.238	0.15	0.263	0.244	0.295	0.338	ns
LVTTTL33_8mA	LVTTTL 8mA drive	-0.346	-0.165	-0.496	-0.296	-0.646	-0.428	ns
LVTTTL33_16mA	LVTTTL 16mA drive	-0.11	-0.18	-0.218	-0.32	-0.325	-0.46	ns
LVTTTL33_24mA	LVTTTL 24mA drive	-0.012	-0.18	-0.099	-0.321	-0.185	-0.463	ns
LVC MOS33_8mA	LVC MOS 3.3 8mA drive	-0.346	-0.165	-0.496	-0.296	-0.646	-0.428	ns
LVC MOS33_16mA	LVC MOS 3.3 16mA drive	-0.11	-0.18	-0.218	-0.32	-0.325	-0.46	ns
LVC MOS33_24mA	LVC MOS 3.3 24mA drive	-0.012	-0.18	-0.099	-0.321	-0.185	-0.463	ns
LVC MOS25_4mA	LVC MOS 2.5 4mA drive	-0.174	0.004	-0.195	0.002	-0.215	0	ns
LVC MOS25_8mA	LVC MOS 2.5 8mA drive	0	0	0	0	0	0	ns
LVC MOS25_12mA	LVC MOS 2.5 12mA drive	0.094	-0.025	0.107	0.096	0.12	0.216	ns
LVC MOS25_16mA	LVC MOS 2.5 16mA drive	0.145	-0.054	0.162	0.063	0.181	0.179	ns
LVC MOS25_OD	LVC MOS 2.5 open drain	0.073	-0.125	0.081	-0.081	0.091	-0.09	ns
LVC MOS18_4mA	LVC MOS 1.8 4mA drive	-0.278	-0.099	-0.312	-0.115	-0.345	-0.131	ns
LVC MOS18_8mA	LVC MOS 1.8 8mA drive	-0.073	-0.078	-0.078	-0.084	-0.083	-0.089	ns

LatticeSC/M Internal Timing Parameters¹ (Continued)

Over Recommended Commercial Operating Conditions at VCC = 1.2V +/- 5%

Parameter	Symbol	Description	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
EBR Timing									
t _{CO_EBR}	CK_Q_DEL	Clock (Read) to output from Address or Data	—	1.900	—	2.116	—	2.335	ns
t _{COO_EBR}	CK_Q_DEL	Clock (Write) to output from EBR output Register	0.390	—	0.444	—	0.498	—	ns
t _{SUDATA_EBR}	D_CK_SET	Setup Data to EBR Memory (Write clk)	-0.173	—	-0.192	—	-0.210	—	ns
t _{HDATA_EBR}	D_CK_HLD	Hold Data to EBR Memory (Write clk)	0.276	—	0.305	—	0.335	—	ns
t _{SUADDR_EBR}	A_CK_SET	Setup Address to EBR Memory (Write clk)	-0.165	—	-0.182	—	-0.200	—	ns
t _{HADDR_EBR}	A_CK_HLD	Hold Address to EBR Memory (Write clk)	0.269	—	0.298	—	0.327	—	ns
t _{SUWREN_EBR}	CE_CK_SET	Setup Write/Read Enable to EBR Memory (Write/Read clk)	0.225	—	0.226	—	0.226	—	ns
t _{HWREN_EBR}	CE_CK_HLD	Hold Write/Read Enable to EBR Memory (write/read clk)	0.073	—	0.095	—	0.116	—	ns
t _{SUCE_EBR}	CS_CK_SET	Clock Enable Setup Time to EBR Output Register (Read clk)	0.261	—	0.269	—	0.276	—	ns
t _{HCE_EBR}	CS_CK_HLD	Clock Enable Hold Time to EBR Out-put Register (Read clk)	0.023	—	0.039	—	0.055	—	ns
t _{RSTO_EBR}	RESET_Q_DEL	Reset To Output Delay Time from EBR Output Register (asynchronous)	—	0.589	—	0.673	—	0.757	ns
Cycle Boosting Timing									
t _{DEL1}	DEL1	Cycle boosting delay 1 applies to PIO, PFU, EBR	—	0.480	—	0.524	—	0.570	ns
t _{DEL2}	DEL2	Cycle boosting delay 2 applies to PIO, PFU, EBR	—	0.922	—	1.005	—	1.090	ns
t _{DEL3}	DEL3	Cycle boosting delay 3 applies to PIO, PFU, EBR	—	1.366	—	1.488	—	1.612	ns

1. Complete timing parameters for a user design will be incorporated when running ispLEVER. This is a sampling of the key timing parameters.

LFSC/M15 Logic Signal Connections: 256 fpBGA^{1,2} (Cont.)

Ball Number	LFSC/M15		
	Ball Function	VCCIO Bank	Dual Function
N12	PB39C	4	
T15	PB40A	4	PCLKT4_3
R16	PB40B	4	PCLKC4_3
L12	PB43A	4	
M12	PB43B	4	
P16	PB44A	4	
N16	PB44B	4	
R14	PB47C	4	VREF1_4
P15	PB48A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D
M13	PB48B	4	LRC_DLLC_IN_C/LRC_DLLC_FB_D
N13	PB49A	4	LRC_PLLT_IN_A/LRC_PLLT_FB_B
P14	PB49B	4	LRC_PLLC_IN_A/LRC_PLLC_FB_B
M16	PR45B	3	LRC_DLLC_IN_F/LRC_DLLC_FB_E
L16	PR45A	3	LRC_DLLT_IN_F/LRC_DLLT_FB_E
M14	PR43B	3	
M15	PR43A	3	
K16	PR41D	3	VREF2_3
J16	PR37B	3	
H16	PR37A	3	
L13	PR35D	3	DIFFR_3
L14	PR35B	3	
L15	PR35A	3	
K12	PR31C	3	VREF1_3
J13	PR28D	3	PCLKC3_2
K13	PR28C	3	PCLKT3_2
H15	PR28B	3	
F16	PR28A	3	
J11	PR26D	3	PCLKC3_1
J12	PR26C	3	PCLKT3_1
J15	PR26B	3	PCLKC3_0
J14	PR26A	3	PCLKT3_0
E16	PR24D	2	PCLKC2_2
D16	PR24C	2	PCLKT2_2
H11	PR24B	2	PCLKC2_0
H12	PR24A	2	PCLKT2_0
H13	PR23B	2	PCLKC2_1
H14	PR23A	2	PCLKT2_1
G12	PR22D	2	DIFFR_2
G13	PR22C	2	VREF1_2
F8	PR22B	2	
F9	PR22A	2	
G16	PR18D	2	VREF2_2
F15	PR17B	2	URC_DLLC_IN_C/URC_DLLC_FB_D

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AF4	PB3C	5	LLC_DLLT_IN_C/LLC_DLLT_FB_D	PB3C	5	LLC_DLLT_IN_C/LLC_DLLT_FB_D
AE5	PB3D	5	LLC_DLLC_IN_C/LLC_DLLC_FB_D	PB3D	5	LLC_DLLC_IN_C/LLC_DLLC_FB_D
AG3	PB4A	5	LLC_DLLT_IN_D/LLC_DLLT_FB_C	PB4A	5	LLC_DLLT_IN_D/LLC_DLLT_FB_C
AH2	PB4B	5	LLC_DLLC_IN_D/LLC_DLLC_FB_C	PB4B	5	LLC_DLLC_IN_D/LLC_DLLC_FB_C
AD6	PB4C	5		PB4C	5	
AJ2	PB5A	5		PB5A	5	
AK2	PB5B	5		PB5B	5	
AD7	PB5C	5		PB5C	5	
AD8	PB5D	5	VREF1_5	PB5D	5	VREF1_5
AH3	PB7A	5		PB11A	5	
AJ3	PB7B	5		PB11B	5	
AF9	PB7C	5		PB11C	5	
AE10	PB7D	5		PB11D	5	
AK3	PB8A	5		PB12A	5	
AJ4	PB8B	5		PB12B	5	
AE11	PB9A	5		PB13A	5	
AF10	PB9B	5		PB13B	5	
AK4	PB11A	5		PB16A	5	
AK5	PB11B	5		PB16B	5	
AH10	PB12A	5	PCLKT5_3	PB20A	5	PCLKT5_3
AH11	PB12B	5	PCLKC5_3	PB20B	5	PCLKC5_3
AF13	PB12C	5	PCLKT5_4	PB20C	5	PCLKT5_4
AE14	PB12D	5	PCLKC5_4	PB20D	5	PCLKC5_4
AK6	PB13A	5	PCLKT5_5	PB21A	5	PCLKT5_5
AK7	PB13B	5	PCLKC5_5	PB21B	5	PCLKC5_5
AF14	PB13C	5		PB21C	5	
AJ11	PB15A	5	PCLKT5_0	PB23A	5	PCLKT5_0
AJ12	PB15B	5	PCLKC5_0	PB23B	5	PCLKC5_0
AH13	PB15D	5	VREF2_5	PB23D	5	VREF2_5
AK8	PB16A	5	PCLKT5_1	PB24A	5	PCLKT5_1
AK9	PB16B	5	PCLKC5_1	PB24B	5	PCLKC5_1
AH14	PB17A	5	PCLKT5_2	PB25A	5	PCLKT5_2
AG14	PB17B	5	PCLKC5_2	PB25B	5	PCLKC5_2
AK10	PB19A	5		PB28A	5	
AK11	PB19B	5		PB28B	5	
AH15	PB20A	5		PB29A	5	
AG15	PB20B	5		PB29B	5	
AH12	PB21A	5		PB31A	5	
AJ13	PB21B	5		PB31B	5	
AD15	PB21C	5		PB31C	5	
AE15	PB21D	5		PB31D	5	
AK12	PB23A	5		PB32A	5	
AK13	PB23B	5		PB32B	5	
AJ14	PB24A	5		PB33A	5	
AJ15	PB24B	5		PB33B	5	

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
G1	NC	-		PL20B	7	
M4	NC	-		NC	-	
J3	NC	-		NC	-	
P5	NC	-		NC	-	
W5	NC	-		PL48C	6	
T6	NC	-		PL35C	6	
U3	NC	-		PL36A	6	
V3	NC	-		PL36B	6	
T5	NC	-		PL39A	6	
T4	NC	-		PL39B	6	
V5	NC	-		PL43C	6	
U6	NC	-		PL42C	6	
U4	NC	-		PL40A	6	
U5	NC	-		PL40B	6	
V4	NC	-		PL43D	6	
Y2	NC	-		PL47A	6	
AA2	NC	-		PL47B	6	
W3	NC	-		PL47D	6	
Y3	NC	-		PL47C	6	
AB3	NC	-		NC	-	
AC4	NC	-		PL53A	6	
AD4	NC	-		PL53B	6	
AE3	NC	-		PL56A	6	
AF3	NC	-		PL56B	6	
AF7	NC	-		PB7A	5	
AF6	NC	-		PB7B	5	
AH4	NC	-		PB8A	5	
AG5	NC	-		PB8B	5	
AF8	NC	-		PB9A	5	
AG8	NC	-		PB9B	5	
AG7	NC	-		NC	-	
AG10	NC	-		NC	-	
AF12	NC	-		NC	-	
AH7	NC	-		PB15A	5	
AE13	NC	-		PB15D	5	
AG13	NC	-		PB23C	5	
AH8	NC	-		PB15B	5	
AJ5	NC	-		PB17A	5	
AJ6	NC	-		PB17B	5	
AF15	NC	-		PB21D	5	
AJ7	NC	-		PB19A	5	
AJ8	NC	-		PB19B	5	
AE12	NC	-		PB15C	5	
AF16	NC	-		PB38D	4	
AF19	NC	-		PB49D	4	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
V25	PL44C	6		PL56C	6	
W25	PL44D	6		PL56D	6	
U34	PL45A	6		PL57A	6	
V34	PL45B	6		PL57B	6	
V26	PL45C	6		PL57C	6	
W26	PL45D	6		PL57D	6	
V33	PL47A	6		PL60A	6	
W33	PL47B	6		PL60B	6	
V24	PL47C	6		PL60C	6	
W24	PL47D	6		PL60D	6	
W31	PL48A	6		PL63A	6	
Y31	PL48B	6		PL63B	6	
Y29	PL48C	6		PL63C	6	
AA29	PL48D	6		PL63D	6	
Y33	PL49A	6		PL65A	6	
AA33	PL49B	6		PL65B	6	
Y28	PL49C	6		PL65C	6	
AA28	PL49D	6		PL65D	6	
AB32	PL51A	6		PL76A	6	
AC32	PL51B	6		PL76B	6	
AA26	PL51C	6		PL76C	6	
AA27	PL51D	6	DIFFR_6	PL76D	6	DIFFR_6
AB31	PL52A	6		PL77A	6	
AC31	PL52B	6		PL77B	6	
Y24	PL52C	6		PL77C	6	
AA24	PL52D	6		PL77D	6	
AE34	PL53A	6		PL78A	6	
AF34	PL53B	6		PL78B	6	
AB30	PL53C	6		PL78C	6	
AC30	PL53D	6		PL78D	6	
AD33	PL56A	6		PL80A	6	
AE33	PL56B	6		PL80B	6	
AD30	PL56C	6		PL80C	6	
AE30	PL56D	6		PL80D	6	
AE32	PL57A	6		PL81A	6	
AF32	PL57B	6		PL81B	6	
AA25	PL57C	6		PL81C	6	
AB25	PL57D	6		PL81D	6	
AJ34	PL58A	6		PL82A	6	
AK34	PL58B	6		PL82B	6	
AB27	PL58C	6		PL82C	6	
AC27	PL58D	6		PL82D	6	
AF33	PL60A	6		PL84A	6	
AG33	PL60B	6		PL84B	6	
AC29	PL60C	6		PL84C	6	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
L1	PR31A	2		PR43A	2	
T10	PR30D	2		PR42D	2	
U10	PR30C	2		PR42C	2	
N2	PR30B	2		PR42B	2	
M2	PR30A	2		PR42A	2	
R11	PR29D	2		PR37D	2	
P11	PR29C	2		PR37C	2	
N4	PR29B	2		PR37B	2	
M4	PR29A	2		PR37A	2	
N5	PR27D	2		PR35D	2	
M5	PR27C	2		PR35C	2	
L2	PR27B	2		PR35B	2	
K2	PR27A	2		PR35A	2	
P8	PR26D	2		PR33D	2	
N8	PR26C	2		PR33C	2	
J2	PR26B	2		PR33B	2	
H2	PR26A	2		PR33A	2	
M6	PR25D	2		PR31D	2	
L6	PR25C	2		PR31C	2	
K3	PR25B	2		PR31B	2	
J3	PR25A	2		PR31A	2	
M8	PR23D	2	DIFFR_2	PR29D	2	DIFFR_2
L8	PR23C	2	VREF1_2	PR29C	2	VREF1_2
K4	PR23B	2		PR29B	2	
J4	PR23A	2		PR29A	2	
M7	PR22D	2		PR21D	2	
L7	PR22C	2		PR21C	2	
J5	PR22B	2		PR21B	2	
H5	PR22A	2		PR21A	2	
N9	PR21D	2		PR20D	2	
P9	PR21C	2		PR20C	2	
G3	PR21B	2		PR20B	2	
F3	PR21A	2		PR20A	2	
J6	PR18D	2	VREF2_2	PR18D	2	VREF2_2
H6	PR18C	2		PR18C	2	
E2	PR18B	2	URC_DLLC_IN_D/URC_DLLC_FB_C	PR18B	2	URC_DLLC_IN_D/URC_DLLC_FB_C
D2	PR18A	2	URC_DLLT_IN_D/URC_DLLT_FB_C	PR18A	2	URC_DLLT_IN_D/URC_DLLT_FB_C
P10	PR17D	2	URC_PLLC_IN_B/URC_PLLC_FB_A	PR17D	2	URC_PLLC_IN_B/URC_PLLC_FB_A
N10	PR17C	2	URC_PLLT_IN_B/URC_PLLT_FB_A	PR17C	2	URC_PLLT_IN_B/URC_PLLT_FB_A
G4	PR17B	2	URC_DLLC_IN_C/URC_DLLC_FB_D	PR17B	2	URC_DLLC_IN_C/URC_DLLC_FB_D
F4	PR17A	2	URC_DLLT_IN_C/URC_DLLT_FB_D	PR17A	2	URC_DLLT_IN_C/URC_DLLT_FB_D
J7	PR16D	2		PR16D	2	
H7	PR16C	2		PR16C	2	
G5	PR16B	2	URC_PLLC_IN_A/URC_PLLC_FB_B	PR16B	2	URC_PLLC_IN_A/URC_PLLC_FB_B
F5	PR16A	2	URC_PLLT_IN_A/URC_PLLT_FB_B	PR16A	2	URC_PLLT_IN_A/URC_PLLT_FB_B

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AN15	PB89A	4	PCLKT4_2
AN14	PB89B	4	PCLKC4_2
AE16	PB89C	4	PCLKT4_7
AD16	PB89D	4	PCLKC4_7
AK15	PB90A	4	PCLKT4_1
AK14	PB90B	4	PCLKC4_1
AG15	PB90C	4	PCLKT4_6
AG14	PB90D	4	PCLKC4_6
AM13	PB91A	4	PCLKT4_0
AM12	PB91B	4	PCLKC4_0
AJ12	PB91C	4	VREF2_4
AJ11	PB91D	4	
AL13	PB93A	4	PCLKT4_5
AL12	PB93B	4	PCLKC4_5
AH12	PB93C	4	
AH11	PB93D	4	
AN13	PB94A	4	PCLKT4_3
AN12	PB94B	4	PCLKC4_3
AD14	PB94C	4	PCLKT4_4
AD15	PB94D	4	PCLKC4_4
AP13	PB87A	4	
AP12	PB87B	4	
AK13	PB87C	4	
AK12	PB87D	4	
AP11	PB97A	4	
AP10	PB97B	4	
AN11	PB113A	4	
AN10	PB113B	4	
AF14	PB113C	4	
AF13	PB113D	4	
AM10	PB115A	4	
AM9	PB115B	4	
AE14	PB115C	4	
AE13	PB115D	4	
AP9	PB118A	4	
AP8	PB118B	4	
AK11	PB118C	4	
AK10	PB118D	4	
AL10	PB121A	4	
AL9	PB121B	4	
AF12	PB121C	4	
AF11	PB121D	4	
AN9	PB123A	4	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
F25	B_HDINN0_L	-	PCS 361 CH 0 IN N
E25	B_HDINP0_L	-	PCS 361 CH 0 IN P
D28	B_VDDIB0_L	-	
G25	VCC12	-	
D29	A_VDDIB3_L	-	
C25	VCC12	-	
A25	A_HDINP3_L	-	PCS 360 CH 3 IN P
B25	A_HDINN3_L	-	PCS 360 CH 3 IN N
A26	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P
E27	VCC12	-	
B26	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N
F26	A_VDDOB3_L	-	
B27	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N
F27	A_VDDOB2_L	-	
A27	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P
E28	VCC12	-	
B28	A_HDINN2_L	-	PCS 360 CH 2 IN N
A28	A_HDINP2_L	-	PCS 360 CH 2 IN P
D30	A_VDDIB2_L	-	
C28	VCC12	-	
D31	A_VDDIB1_L	-	
C29	VCC12	-	
A29	A_HDINP1_L	-	PCS 360 CH 1 IN P
B29	A_HDINN1_L	-	PCS 360 CH 1 IN N
A30	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P
E29	VCC12	-	
B30	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N
F28	A_VDDOB1_L	-	
B31	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N
F29	A_VDDOB0_L	-	
A31	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P
E30	VCC12	-	
B32	A_HDINN0_L	-	PCS 360 CH 0 IN N
A32	A_HDINP0_L	-	PCS 360 CH 0 IN P
D32	A_VDDIB0_L	-	
C32	VCC12	-	
E34	PL30A	7	
F34	PL30B	7	
F33	PL34A	7	
G33	PL34B	7	
K30	PL38A	7	
L30	PL38B	7	
G34	PL40A	7	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
H34	PL40B	7	
M32	PL53A	7	
N32	PL53B	7	
P28	PL53C	7	
R28	PL53D	7	
J34	PL55A	7	
K34	PL55B	7	
P30	PL55C	7	
R30	PL55D	7	
W34	PL73A	6	
Y34	PL73B	6	
W32	PL75A	6	
Y32	PL75B	6	
AA34	PL78A	6	
AB34	PL78B	6	
AC34	PL81A	6	
AD34	PL81B	6	
Y30	PL82A	6	
AA30	PL82B	6	
AB33	PL83A	6	
AC33	PL83B	6	
AC2	PR83B	3	
AB2	PR83A	3	
AA5	PR82B	3	
Y5	PR82A	3	
AD1	PR81B	3	
AC1	PR81A	3	
AB1	PR78B	3	
AA1	PR78A	3	
Y3	PR75B	3	
W3	PR75A	3	
Y1	PR73B	3	
W1	PR73A	3	
R5	PR55D	2	
P5	PR55C	2	
K1	PR55B	2	
J1	PR55A	2	
R7	PR53D	2	
P7	PR53C	2	
N3	PR53B	2	
M3	PR53A	2	
H1	PR40B	2	
G1	PR40A	2	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AL5	GND	-	
AM14	GND	-	
AM18	GND	-	
AM24	GND	-	
AM30	GND	-	
AM8	GND	-	
AN1	GND	-	
AN34	GND	-	
AP2	GND	-	
AP33	GND	-	
B1	GND	-	
B34	GND	-	
C11	GND	-	
C12	GND	-	
C13	GND	-	
C14	GND	-	
C17	GND	-	
C21	GND	-	
C22	GND	-	
C23	GND	-	
C24	GND	-	
C26	GND	-	
C27	GND	-	
C30	GND	-	
C31	GND	-	
C4	GND	-	
C5	GND	-	
C8	GND	-	
C9	GND	-	
D18	GND	-	
E32	GND	-	
E4	GND	-	
F19	GND	-	
G16	GND	-	
G29	GND	-	
G7	GND	-	
H3	GND	-	
H31	GND	-	
J10	GND	-	
J15	GND	-	
J26	GND	-	
K20	GND	-	
K23	GND	-	

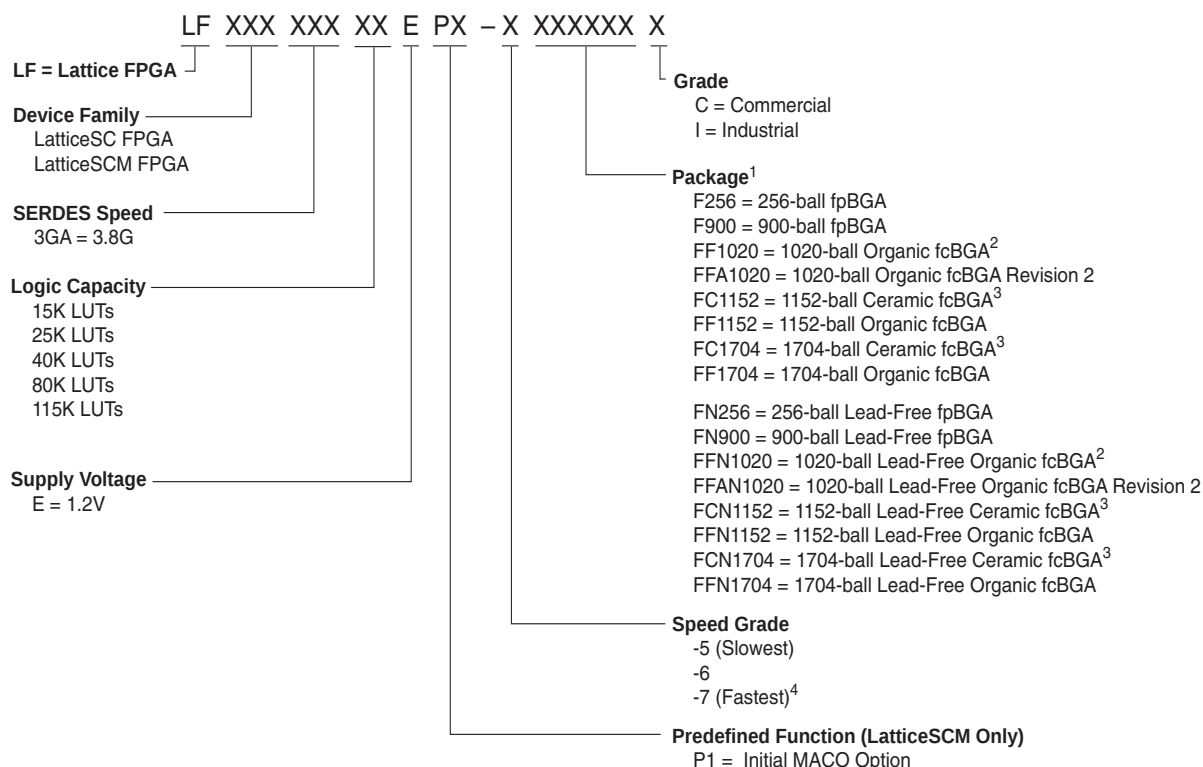
LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
W7	GND	-	
AA14	VCC	-	
AA16	VCC	-	
AA17	VCC	-	
AA18	VCC	-	
AA19	VCC	-	
AA21	VCC	-	
AB13	VCC	-	
AB22	VCC	-	
N13	VCC	-	
N22	VCC	-	
P14	VCC	-	
P16	VCC	-	
P17	VCC	-	
P18	VCC	-	
P19	VCC	-	
P21	VCC	-	
R15	VCC	-	
R17	VCC	-	
R18	VCC	-	
R20	VCC	-	
T14	VCC	-	
T16	VCC	-	
T19	VCC	-	
T21	VCC	-	
U14	VCC	-	
U15	VCC	-	
U17	VCC	-	
U18	VCC	-	
U20	VCC	-	
U21	VCC	-	
V14	VCC	-	
V15	VCC	-	
V17	VCC	-	
V18	VCC	-	
V20	VCC	-	
V21	VCC	-	
W14	VCC	-	
W16	VCC	-	
W19	VCC	-	
W21	VCC	-	
Y15	VCC	-	
Y17	VCC	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
W33	PL42C	7		PL56C	7	
Y33	PL42D	7		PL56D	7	
W37	PL43A	7		PL57A	7	
Y37	PL43B	7		PL57B	7	
Y32	PL43C	7		PL57C	7	
AA32	PL43D	7		PL57D	7	
U38	PL46A	7		PL60A	7	
V38	PL46B	7		PL60B	7	
W34	PL46C	7		PL60C	7	
Y34	PL46D	7		PL60D	7	
T40	PL47A	7	PCLKT7_1	PL61A	7	PCLKT7_1
U40	PL47B	7	PCLKC7_1	PL61B	7	PCLKC7_1
AA33	PL47C	7	PCLKT7_3	PL61C	7	PCLKT7_3
AB33	PL47D	7	PCLKC7_3	PL61D	7	PCLKC7_3
R42	PL48A	7	PCLKT7_0	PL62A	7	PCLKT7_0
T42	PL48B	7	PCLKC7_0	PL62B	7	PCLKC7_0
AA34	PL48C	7	PCLKT7_2	PL62C	7	PCLKT7_2
AB34	PL48D	7	PCLKC7_2	PL62D	7	PCLKC7_2
U41	PL50A	6	PCLKT6_0	PL64A	6	PCLKT6_0
V41	PL50B	6	PCLKC6_0	PL64B	6	PCLKC6_0
V36	PL50C	6	PCLKT6_1	PL64C	6	PCLKT6_1
W36	PL50D	6	PCLKC6_1	PL64D	6	PCLKC6_1
U42	PL51A	6		PL65A	6	
V42	PL51B	6		PL65B	6	
AB31	PL51C	6	PCLKT6_3	PL65C	6	PCLKT6_3
AC31	PL51D	6	PCLKC6_3	PL65D	6	PCLKC6_3
W38	PL52A	6		PL66A	6	
Y38	PL52B	6		PL66B	6	
AA35	PL52C	6	PCLKT6_2	PL66C	6	PCLKT6_2
AB35	PL52D	6	PCLKC6_2	PL66D	6	PCLKC6_2
W39	PL55A	6		PL69A	6	
Y39	PL55B	6		PL69B	6	
AB32	PL55C	6	VREF1_6	PL69C	6	VREF1_6
AC32	PL55D	6		PL69D	6	
W40	PL56A	6		PL70A	6	
Y40	PL56B	6		PL70B	6	
AA36	PL56C	6		PL70C	6	
AB36	PL56D	6		PL70D	6	
W41	PL57A	6		PL71A	6	
Y41	PL57B	6		PL71B	6	
AA37	PL57C	6		PL71C	6	
AB37	PL57D	6		PL71D	6	
W42	PL59A	6		PL73A	6	
Y42	PL59B	6		PL73B	6	
AC33	PL59C	6		PL73C	6	

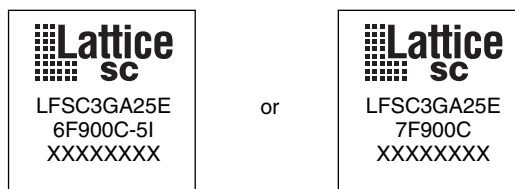
Part Number Description



1. fpBGA = 1.0 mm pitch BGA, fcBGA = 1.0 mm flip-chip BGA (organic and ceramic).
2. Converted to organic fcBGA per PCN #02A-10.
3. Converted to organic fcBGA per PCN #01A-10.
4. Not available in the LatticeSC115 and LatticeSCM115 devices.

Ordering Information

Depending on the speed and temperature grade, the device can either be dual marked or single marked. The commercial grade is one speed grade faster than the associated dual marked industrial grade. The slowest commercial speed grade does not have industrial markings. The markings appear as follows:



Temperature Grade	Speed Grade	Single or Dual Mark?
Commercial	-7	Either OK
	-6	Dual Only
	-5	Single Only
Industrial	-6	Either OK
	-5	Dual Only

Industrial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA40EP1-6FF1020I ¹	-6	Organic fcBGA	1020	IND	40.4
LFSCM3GA40EP1-5FF1020I ¹	-5	Organic fcBGA	1020	IND	40.4
LFSCM3GA40EP1-6FFA1020I	-6	Organic fcBGA Revision 2	1020	IND	40.4
LFSCM3GA40EP1-5FFA1020I	-5	Organic fcBGA Revision 2	1020	IND	40.4
LFSCM3GA40EP1-6FC1152I ²	-6	Ceramic fcBGA	1152	IND	40.4
LFSCM3GA40EP1-5FC1152I ²	-5	Ceramic fcBGA	1152	IND	40.4
LFSCM3GA40EP1-6FF1152I	-6	Organic fcBGA	1152	IND	40.4
LFSCM3GA40EP1-5FF1152I	-5	Organic fcBGA	1152	IND	40.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).2. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA80E-6FC1152I ¹	-6	Ceramic fcBGA	1152	IND	80.1
LFSC3GA80E-5FC1152I ¹	-5	Ceramic fcBGA	1152	IND	80.1
LFSC3GA80E-6FF1152I	-6	Organic fcBGA	1152	IND	80.1
LFSC3GA80E-5FF1152I	-5	Organic fcBGA	1152	IND	80.1
LFSC3GA80E-6FC1704I ¹	-6	Ceramic fcBGA	1704	IND	80.1
LFSC3GA80E-5FC1704I ¹	-5	Ceramic fcBGA	1704	IND	80.1
LFSC3GA80E-6FF1704I	-6	Organic fcBGA	1704	IND	80.1
LFSC3GA80E-5FF1704I	-5	Organic fcBGA	1704	IND	80.1

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA80EP1-6FC1152I ¹	-6	Ceramic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-5FC1152I ¹	-5	Ceramic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-6FF1152I	-6	Organic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-5FF1152I	-5	Organic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-6FC1704I ¹	-6	Ceramic fcBGA	1704	IND	80.1
LFSCM3GA80EP1-5FC1704I ¹	-5	Ceramic fcBGA	1704	IND	80.1
LFSCM3GA80EP1-6FF1704I	-6	Organic fcBGA	1704	IND	80.1
LFSCM3GA80EP1-5FF1704I	-5	Organic fcBGA	1704	IND	80.1

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Date	Version	Section	Change Summary
June 2006 (cont.)	01.2 (cont.)	DC and Switching Characteristics (cont.)	Updated Typical Building Block Performance with ispLEVER 6.0 values.
			Updated LatticeSC External Switching Characteristics with ispLEVER 6.0 values.
			Updated Lattice SC Internal Timing Parameters with ispLEVER 6.0 values.
			Updated Lattice SC Family Timing Adders with ispLEVER 6.0 values
			Changed % spread from 1 to 0.5 min and from 3 to 1.5 max.
			Changed conditions to refer to “with multiplication” and “without multiplication”.
			Changed the formula for t_{OPJIT} with multiplication (same result, different representation).
		Pinout Information	Expanded definition of NC.
			Expanded definition of GND.
			Expanded definition of VTT_x.
			Expanded definition of VCC12.
			Added accuracy of TEMP pin.
			Added RESPN_[ULC/URC].
			Updated Pin Information Summary with additional devices and packages.
			Added additional devices and packages pinouts.
			Removed Power Supply and NC connections table
			Removed VTT table
			Removed LFSC25 Logic Signal Connections: 900-Ball fBGA1 table
			Changed all VDDP, VDDTX and VDDR _X to VCC12.
		Ordering Information	Added dual marking.
			Added lead free packaging information to part number description.
August 2006	01.3	Introduction	Added SC40 1152 information to Table 1-1.
			Updated Table 1-3 with ispLEVER 6.0 SP1 results.
		Architecture	Added SSTL18 II to Table 2-8.
			Changed Table 2-10 VCCIO column to “N/A” for LVDS, mini-LVDS, BLVDS25, MLVDS25, HYPT and RSDS.
			Changed Hypertransport performance to 700 MHz (1400 Mbps) in Table 2-11.
			Changed SPI4.2 performance to 500 MHz (1000 Mbps) in Table 2-11
			Added “On packages that include PROBE_GND, the most accurate measurements will occur between the TEMP pin and the PROBE_GND pin. On packages that do not include PROBE_GND, measurements should be made between the TEMP pin and board ground.”
			Added VCCIO of 2.5 V for LVPECL33 in table 2-9.
		DC and Switching Characteristics	Updated Typical Building Block Performance with ispLEVER 6.0 SP1 results.
			Updated Initialization and Standby Supply Current table to break out ICC and ICC12.
			Updated LatticeSC External Switching Characteristics with ispLEVER 6.0 SP1 results.
			Updated LatticeSC Internal Timing Parameters with ispLEVER 6.0 SP1 results.